

HEP_07: SiW ECAL

T. Suehara (Kyushu University) on behalf of SiW-ECAL group





ILD: one of two ILC detector concepts ILD ECAL: 20-30 layers of sandwich calorimeter with tungsten absorber and 5x5 mm - segmented silicon diodes (~ 10⁸ channels in total) PCB with ASICs (SKIROC2) embedded



Achievements in FY2018

- Two test beams at DESY and CERN SPS
 - Analysis on 2017 test beam submitted to NIMA
- New tech. prototype (FEV13/SMBv5) designed in LLR/Kyushu and assembled in Kyushu
 - With new 650 μm silicon sensors
- Redesigning ECAL structure for cost optimization and adopting thicker/bigger silicon sensors
- Analysis on physics performance of ILC/ILD for tau final states
 - Higgs CP analysis published in PRD
 - $-e^+e^- \rightarrow \tau^+\tau^-$ for detector optimization

Beam-test 2015-2018



Paper on TB 2017 DESY

Beam test performance of the highly granular SiW-ECAL technological prototype for the ILC.

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Abstract

The technological prototype of the CALICE highly granular silicon-tungsten electromagnetic calorimeter (SiW-ECAL) tested in beam at DESY in 2017. In this test the setup comprised seven layers of 1024 channels and a size of 18×18 cm² each. This article presents key performance results in terms of signal over noise ratios at different levels of the readout chain and a study of the uniformity of the detector response.

Keywords: Calorimeter methods, calorimeters, Si and pad detectors

arXiv: 1902.00110

Under review in NIMA



S/N ratio of around 20 is obtained for most of channels

Good detection efficiency is observed with penetrating MIPs

Taikan Suehara, TYL/FJPPL/FKPPL workshop at Jeju, 9 May 2019 page 5

8

4 6

ASIC

Figure 8: MIP detection efficiency in high purity samples of tracks of MIP-like acting particles for all layers. The average for all readout channels in each ASICs is shown. The error bars correspond to the

standard deviation of the efficiency distribution of all channels in th

10 12 14

ASIC number

Major changes for the 2018 prototype (FEV13)

- ASIC: SKIROC2 → SKIROC2A
 - Individual threshold control
 - Improvements on TDC
- Dedicated power plane for AVDD PA
 - Power layers: $2 \rightarrow 3$
 - Total layers: $10 \rightarrow 12$
- Smaller SMB footprint
- Connection by 0.4mm-pitch flex cables
 - Two candidates, footprint compatible
- Power pulsing capacitor on FEV
 - 0.4 mm thickness, 40 mF x 6







Designed and produced in LLR/Kyushu collaboration

SILKSCREEN CI



Micro-coaxial cable by KEL Flexible cable with Panasonic connector



Thin capacitor used to provide power pulsing current



Assembly of FEV13 (in Kyushu)

11 1111

Glue dispenser & sensor pick up

MUSASH

Gluing flex to PCB/sensor assembly with automatic alignment



Conductive glue (E4110-LV, silver-epoxy)



P3

Test with radiation source

K1

K2

5 assembled slabs, Sep. 2018 Taikan Suehara, TYL/FJPPL/FKPPL workshop at Jeju, 9 May 2019 page 7

P2

P1

Quick look of results at test beams



Hit map of FEV13 at CERN: some part is not responding due to HV connection

S/N ratio is ~ 2 times higher A pion event showing a track Mainly due to bigger MIP signal Taikan Suehara, TYL/FJPPL/FKPPL workshop at Jeju, 9 May 2019 page 8

Structure studies and optimization



Edge of the ECAL with various sensor shapes

study of high energy tau reconstruction at ILC

 $e^+ \ e^- \rightarrow \tau^+ \ \tau^-$ at 500 GeV, full simulation, realistic reconstruction

main aims:

extract tau polarisation (hadronic decays)
 → strong handle to spin-dependent effects in 2-fermion processes

compare larger/smaller detector models

key points:

identification of hadronic tau decay modes $\rightarrow \pi^0$ identification and energy measurement $\rightarrow key$ role for high granularity ECAL

some small differences between detector models in ability to distinguish decay modes



measurement of CP properties in $H \rightarrow \tau^+ \tau^-$

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 ψ_{CP} is mixing angle between even and odd CP components

- CP of T⁺ T⁻ pair from H decay is reflected in correlations between T spins
- High granularity ECAL of ILD crucial in identification of tau leptons and estimation of their spin orientation
- Full simulation and reconstruction study in ILD at ILC-250, assuming 2 ab⁻¹ \rightarrow sensitivity on ψ_{CP} at the level of ~4.3°



Plans in FY2019

- Test beam in DESY in June-July 2019
 - Optimization of FEV13 support structure
 - New FE electronics (SL-board) developed in LAL
- Production of new prototype towards module-0 if ILC gets clearer green signal
 - 8-inch wafers
 - A pair of long slabs (1.5 m long) with ILD-design tungsten structure
- Finish analysis on test beam 2018
 - Long slabs, FEV13, ...

Working hypotheses

1 The ILC is decided this year

- We still have 3–4 years of R&D before launching the production

| ILD assembly timeline for Hybrid option (CMS style assembly)) | | | | | | | | | | | | | |
|---|------|-----|------|------|------------------------------|------|------|------|--------|---------|----------------------|---------|--|
| 2017 | 2019 | | 2020 | 2021 | 2022 | 2023 | 2024 | 2025 | | 2026 | | 2027 | |
| Sub-detector | Y- | 3 | Y-2 | Y-1 | Y1 | Y2 | Y3 | Y4 | Y4 | | 5 | Y6 | |
| ECAL (Barrel) | R&D | | TDR | | Construction off site | | | | | | Ass. On site Install | | |
| ECAL (End cap) | R&D | | TDR | | Construction off site Ass. (| | | | |)n site | Install | | |
| HCAL (Barrel) | R&D | TDR | | | Construction off site | | | | | Ass. C | n site | Install | |
| HCAL (End cap) | R&D | TDR | | | Construction off site Ass. C | | | | n site | Install | | | |

- The organisation

adapted from 2014 ressource survey

- should switch from "loose R&D" to project mode,
- "ILD-like" steps-up in 2020 as main organisation (view of IN2P3)
 - CALICE to publish legacy papers for references
- Decision on staging scheme ≤ end 2020 ?
- Decision on 1 vs 2 experiments ≤ end 2020 ?
 - if 2) conservative: decide on SiW-ECAL parameters
 - if 1) merge SiD & ILD concepts:
 - highly political \rightarrow 1(2) year delay ?

The ILC is not decided;
 CEPC becomes the NLO machine and N^{1.5}LO CLIC

- Decision within 3–4 years ? CLIC TDR in 2025 ?
- Detector R&D must foster on continous operation mode:
 - Adapted electronics and DAQ
 - Active cooling
 - ILD model must be revised (esp. cost, granularity):
 - 2 detectors for 500M\$? [2019-03 CEPC Calo Topical WS]
- The organisation stays R&D oriented, à la CALICE
 - partial evaporation of interest and support are unavoidable
- ③ CEPC and CLIC don't concretise;
 FCC-ee as N²LO projects
 - The organisation stays R&D oriented, à la CALICE
 - Planning is fuzzy; same case as ② in worse...

Preparation for test beam at DESY in June-July





Carbon frame of FEV13 replaced to solve the HV connection issues found at the last TB

A new interface card (SL-board) developed in LAL, commissioning ongoing



Chip-on-board version of FEV11 (with thinner board) will also be tested

See talk by Mitra Ghergherehchi (FKPPL, SKKU) _T



Design of slab stack to accommodate both FEV12-LAL with new interface and FEV13

Summary

- France-Japan collaboration got stronger in FY2018
 - More detailed collaboration of the slab assembly
 - Continued effort on the sensor, ASIC, test beam analysis and physics
 - Results on test beam in 2017 will soon be published
- A more test beam foreseen in DESY in June-July
 - Complete FEV13 development and commissioning of new electronics
 - Expect more manpower on analysis ightarrow quick publication in scope
- Plan after FY2020 strongly depends on project status (of ILC and other lepton colliders)